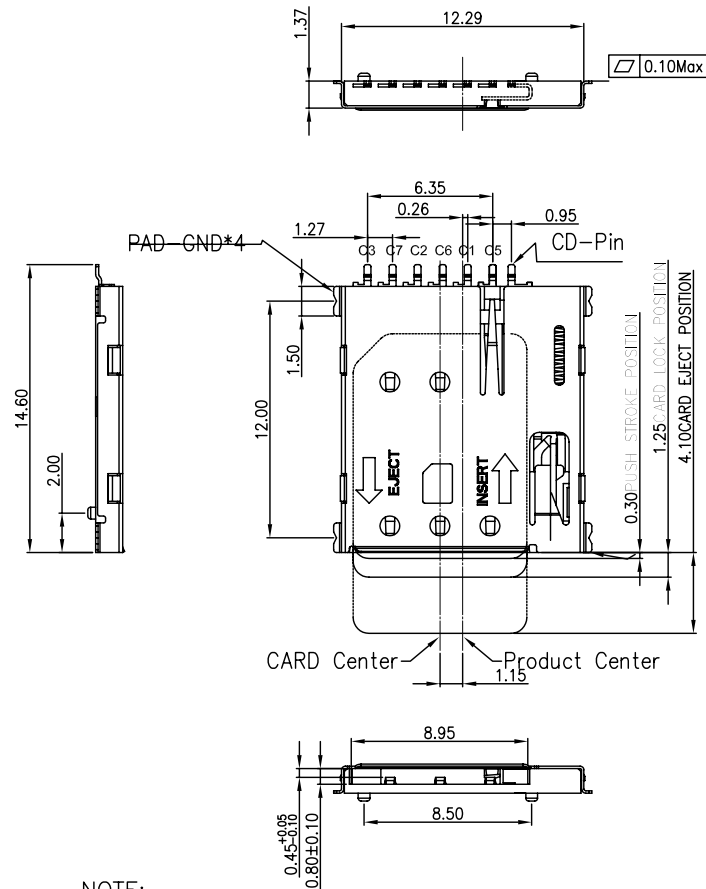
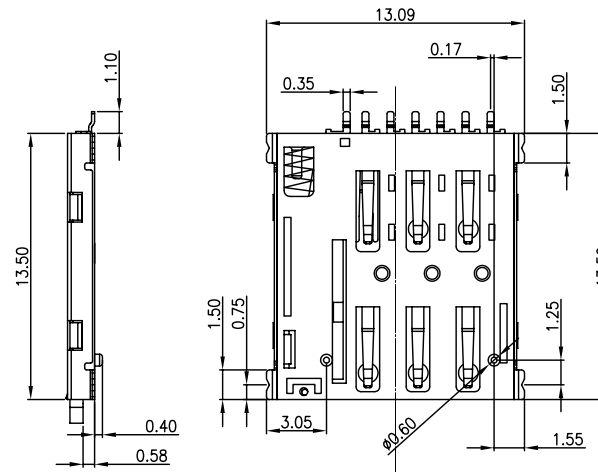


5		6		7		8	
REV.	DATE	ECN NO.	MODIFICATION			APPROVER	
A	2014/07/07	/	NEW			Vicky	

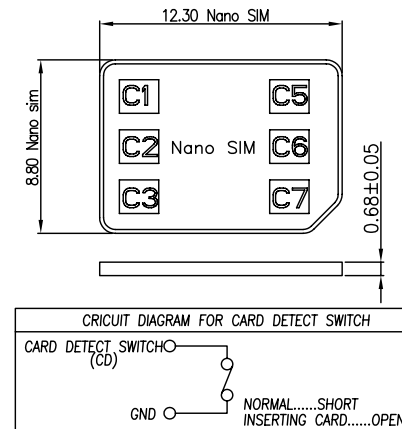
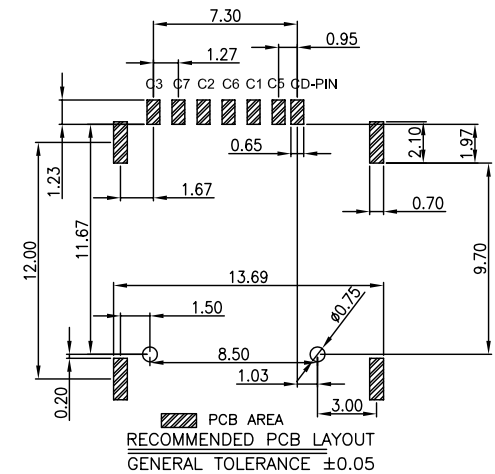


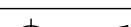
NOTE:

1. Material:
 - 1-1 Housing:Thermoplastic,Color Black UL 94V-0
 - 1-2 Contact: Copper Alloy
 - 1-3 Cover: SUS
2. Plating:
 - 2-1.Contact area: Gold Plated.
 - 2-2.Shell: Plated Ni Overall,PAD Gold Plated
3. Specification:
 - 3-1.Current Rating :0.5mA max.
 - 3-2.Voltage Rating :125V AC/DC
 - 3-3.Contact Resistance: 100 mOhms max
 - 3-4.Insulation Resistance:1000 MOhms min./500VDC
 - 3-5.Dielectric Withstanding Voltage:500 V AC/1minute
 - 3-6.Operating Temperature:-20°C to+60°C
 - 3-7.Mating Cycles:3000 Insertions



SIM pin assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



GENERAL TOLERANCE				UNITS mm		NAME: NANO SIM		<div>ATOM® 深圳市爱特姆科技有限公司</div> <div>SHENZHEN ATOM TECHNOLOGY CO.,LTD.</div>			
SELECT	✓			MAT'L	PART NO: SI73C-01200	TITLE: NANO SIM CARD 6P PUSH PUSH SMT H=1.35mm 带检测脚带柱					
TOL. ON.	1	2	3								
X.XXX	±0.10	±0.05	±0.15	FINISH	APPD: Jason	DWG NO. ATOM-A03621					
X.XX	±0.20	±0.13	±0.25		CHKD: Vicky						
X.X	±0.35	±0.25	±0.50	Q'TY	DR: Jillian		SCALE	SHEET	REV		
X.		±0.38	±1.00				1:1	1/1	A		
ANGLE	±2°										